

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Thomas, *et al.* Docket No.: INF 2003 P 54322 US
Serial No.: 10/790,907 Art Unit: 2822
Filed: March 2, 2004 Examiner: Bac H. Au
For: Integrated Circuit with Re-Route Layer and Stacked Die Assembly

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT

Dear Sir:

The following amendments and remarks are presented in response to the Examiner's
Office Action mailed July 26, 2007. Please amend the above-referenced application as follows.